MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data speet

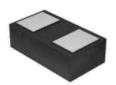


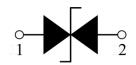
Features

80 Watts peak pulse power (tp = 8/20μs)
Transient protection for high speed data lines to
IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
IEC 61000-4-4 (EFT) 40A (5/50ns)
Working voltages : 5V
Protects One Power or I/O Port
Low operating and clamping voltages
Solid-state silicon avalanche technology

Pin Description

Schematic Diagram





DFN1006P2X

Applications

Notebooks, Desktops, Servers and Video Graphics Cards USB Power & Data Line Protection Monitors and Flat Panel Displays I²C Bus Protection Portable Instrumentation Set Top Box

Maximum Rating @ Ta=25°C unless otherwise specified

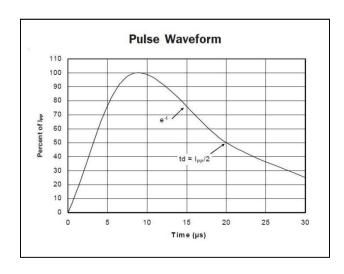
Symbol	Parameter	Ratings	Units
P _{PK}	Peak Pulse Power (tp = 8/20μs)	80	Watts
TL	Lead Soldering Temperature	260(10sec.)	$^{\circ}$
TJ	Operating Temperature	-55 to +125	$^{\circ}$
T _{STG}	Storage Temperature	-55 to +150	$^{\circ}$

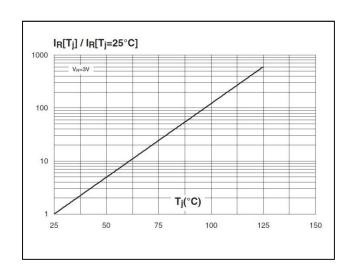


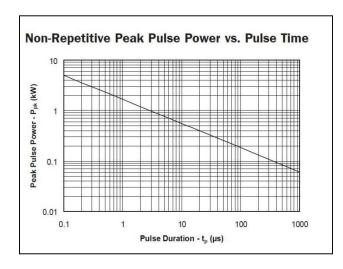
Electrical Characteristics@ Ta=25°C unless otherwise

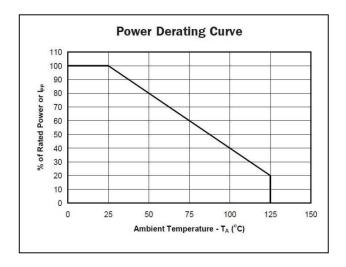
	VRWM@IR		VBR@ImA	Vc@1	Vc@IPP		CJ
P/N	V	μΑ	V	V	V	Α	pF
		MAX	MIN	MAX	MAX		TYP
AZ5325-01F.R7G	5	1	5.8	11.8	15	5	2.5

Typical Characteristics@ Ta=25°C unless otherwise specified

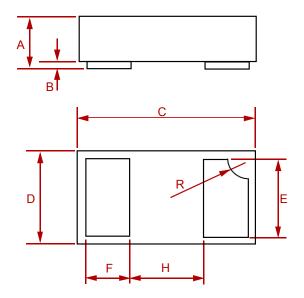






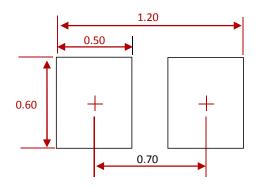


PACKAGE MECHANICAL DATA



Dim	Inc	hes	Millimeters		
Dim	MIN	MAX	MIN	MAX	
Α	0.0125	0.02	0.32	0.52	
В	0.000	0.002	0.00	0.05	
С	0.037	0.043	0.95	1.080	
D	0.022	0.027	0.55	0.680	
Е	0.016	0.024	0.40	0.60	
F	0.008	0.012	0.20	0.30	
Н	0.015Typ.		0.40Typ.		
R	0.001	0.005	0.05	0.15	

Suggested Pad Layout



NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

REEL SPECIFICATION

P/N	PKG	QTY
AZ5325-01F.R7G	DFN1006P2X	12000



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